Amendments to the Claims:

This listing of claims will replace all prior versions, and listings, of claims in the application:

1. (Original) A method for plating CoNiFe comprising:

(a) providing a plating solution including hydroxymethyl-p-tolylsulfone, the plating

solution being configured to provide a CoNiFe film having a high saturation magnetic flux

density and having a composition of 50-70 weight percent of Fe and 3-8 weight percent of Ni;

and

(b) plating the CoNiFe film on a substrate in the plating solution.

2. (Original) The method of claim 1 wherein the plating solution providing step (a)

further includes the step of:

(a1) configuring the plating solution to provide the CoNiFe film having the high

saturation magnetic flux density of greater than 2.2 Tesla and having a composition of 58-62

weight percent of Fe and 3.5-4 weight percent of Ni.

3. (Original) The method of claim 1 wherein the plating solution providing step (a)

further includes:

(a1) configuring the plating solution to ensure that the CoNiFe film is a soft magnetic

film.

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4. (Original) The method of claim 3 wherein the CoNiFe film has a hard axis coercivity of less than or equal to two Oe and an easy axis coercivity of less than or equal to six Oe.

- 5. (Original) The method of claim 1 wherein the plating solution providing step (a) further includes:
- (a1) configuring the plating solution to ensure that the CoNiFe film has a low perpendicular anisotropy field of less than thirty five Oe.
- 6. (Original) The method of claim 5 wherein the CoNiFe film has the low perpendicular anisotropy field of less than twenty Oe.
 - 7. (Original) The method of claim 1 further comprising the steps of:
- (c) adjusting the plating solution after step (b) to maintain the plating of the CoNiFe film having the composition and the saturation magnetic flux density; and
 - (d) plating a second CoNiFe film.
- 8. (Original) The method of claim 1 wherein the plating solution providing step (a) further includes:
- (a1) including CoSO₄, NiSO₄, FeSO₄, NH₄Cl, boric acid, Sodium lauryl sulfate, and saccharin in the plating solution.

9. (Original) The method of claim 1 wherein the plating solution providing step (a) further includes:

- (a1) maintaining the plating solution at a pH of less than 3.
- 10. (Original) The method of claim 9 wherein the plating solution providing step (a1) further includes:
 - (a1i) maintaining the plating solution at the pH of substantially 2.8.
 - 11. (Currently Amended) A magnetic recording head comprising:
 - a first pole;
 - a second pole;
 - a write coil residing between the first pole and the second pole;
 - a write gap residing between a portion of the first pole and a portion of the second pole;

wherein at least a portion of the first pole and/or the second pole are plated using a plating solution including hydroxymethyl-p-tolylsulfone (HPT), the plating solution being configured to such that the at least the portion includes a CoNiFe film having a high saturation magnetic flux density and having a composition of 50-70 weight percent of Fe and 3-8 weight percent of Ni.

12. (Original) The magnetic recording head of claim 11 wherein the CoNiFe film has the high saturation magnetic flux density of greater than 2.2 Tesla and a composition of 58-62 weight percent of Fe and 3.5-4 weight percent of Ni.

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13. (Original) The magnetic recording head of claim 11 wherein the CoNiFe film is a soft magnetic film.

- 14. (Original) The magnetic recording head of claim 13 wherein the CoNiFe film has a hard axis coercivity of less than or equal to two Oe and an easy axis coercivity of less than or equal to six Oe.
- 15. (Original) The magnetic recording head of claim 11 wherein the CoNiFe film has a low perpendicular anisotropy field of less than thirty five Oe.
- 16. (Original) The magnetic recording head of claim 11 wherein the CoNiFe film has the low perpendicular anisotropy field of less than twenty Oe.

Amendments to the Drawings:

Applicant has attached nine (9) sheets of substitute figures making analogous amendments and correcting minor errors.

Attachment: Replacement Sheets